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Stocking Distributor

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[GP1M003A050CG](#)

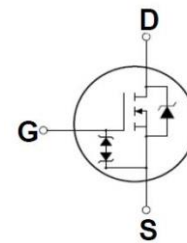
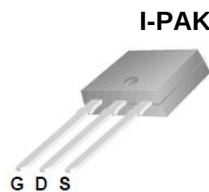
For any questions, you can email us directly:

sales@integrated-circuit.com

Features

- Low gate charge
- 100% avalanche tested
- Improved dv/dt capability
- RoHS compliant
- Halogen free package
- JEDEC Qualification

BV_{DSS}	I_D	$R_{DS(on)}$
500V	2.5A	<2.8Ω



Device	Package	Marking	Remark
GP1M003A050CG	D-PAK	GP1M003A050CG	RoHS
GP1M003A050PG	I-PAK	GP1M003A050PG	RoHS

Absolute Maximum Ratings

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V _{DSS}	500	V
Gate-Source Voltage		V _{GS}	±30	V
Continuous Drain Current	T _C = 25 °C	I _D	2.5	A
	T _C = 100 °C		1.8	A
Pulsed Drain Current ^(Note 1)		I _{DM}	10	A
Single Pulse Avalanche Energy ^(Note 2)		E _{AS}	107	mJ
Repetitive Avalanche Current ^(Note 1)		I _{AR}	2.5	A
Repetitive Avalanche Energy ^(Note 1)		E _{AR}	5.2	mJ
Power Dissipation	T _C = 25 °C	P _D	52	W
	Derate above 25 °C		0.41	W/°C
Peak Diode Recovery dv/dt ^(Note 3)		dv/dt	4.5	V/ns
Operating Junction and Storage Temperature Range		T _J , T _{STG}	-55~150	°C
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		T _L	300	°C

* Limited only by maximum junction temperature

Thermal Characteristics

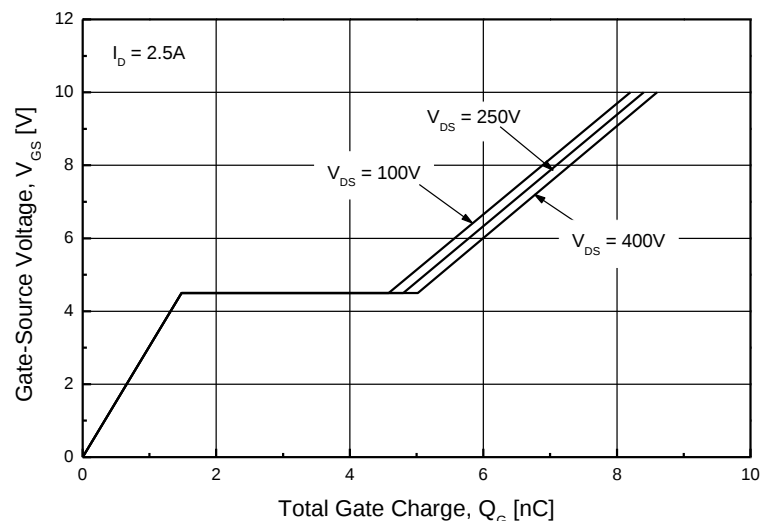
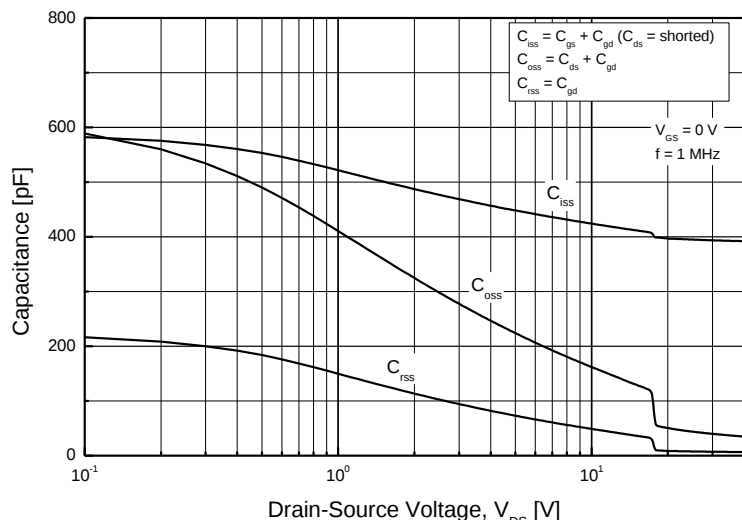
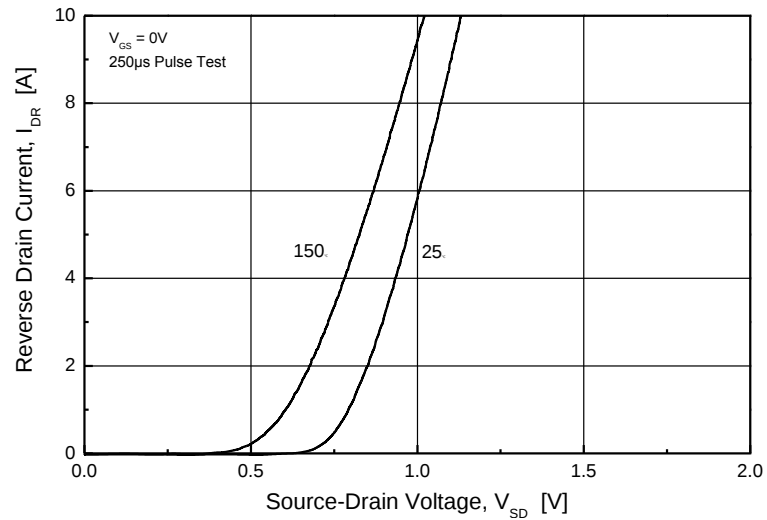
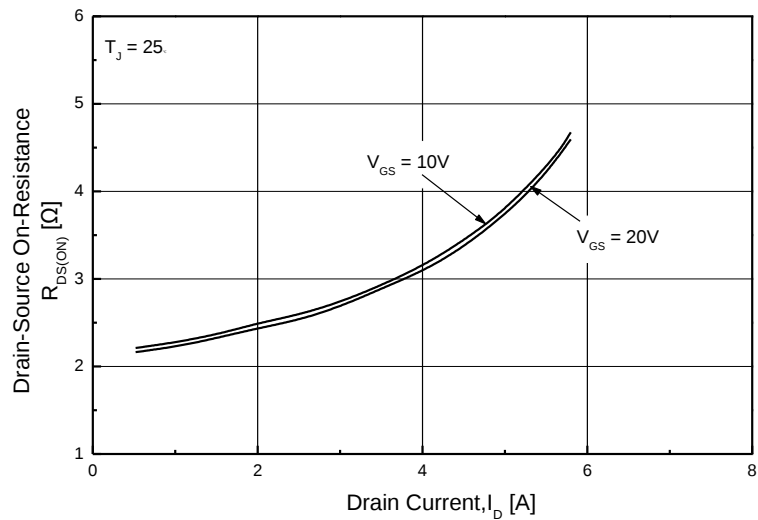
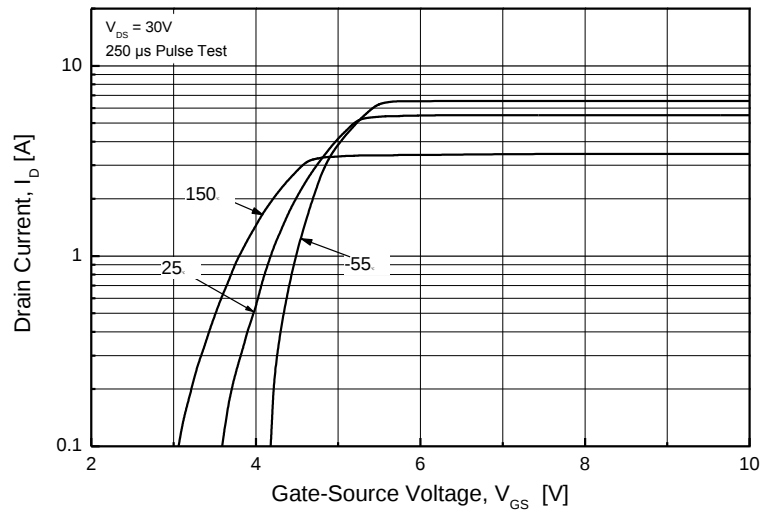
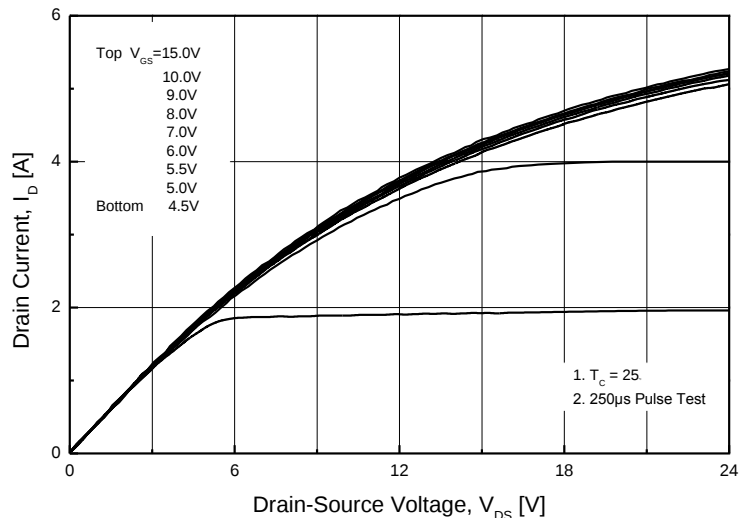
Parameter	Symbol	Value	Unit
Maximum Thermal resistance, Junction-to-Case	R_{qJC}	2.4	°C/W
Maximum Thermal resistance, Junction-to-Ambient	R_{qJA}	110	°C/W

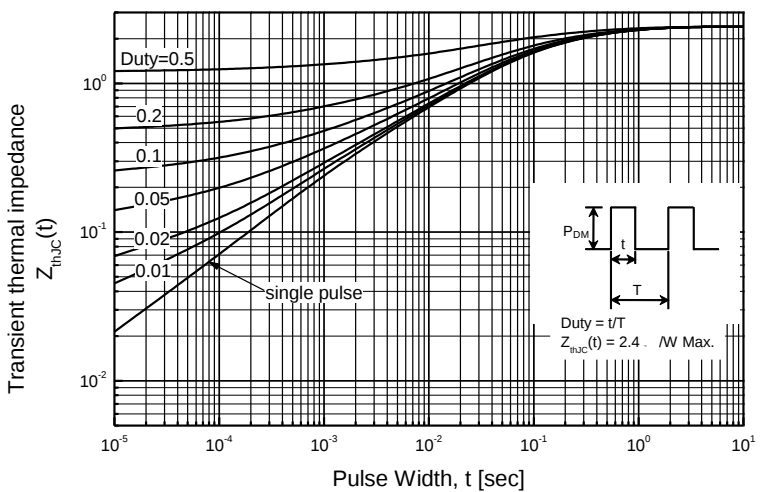
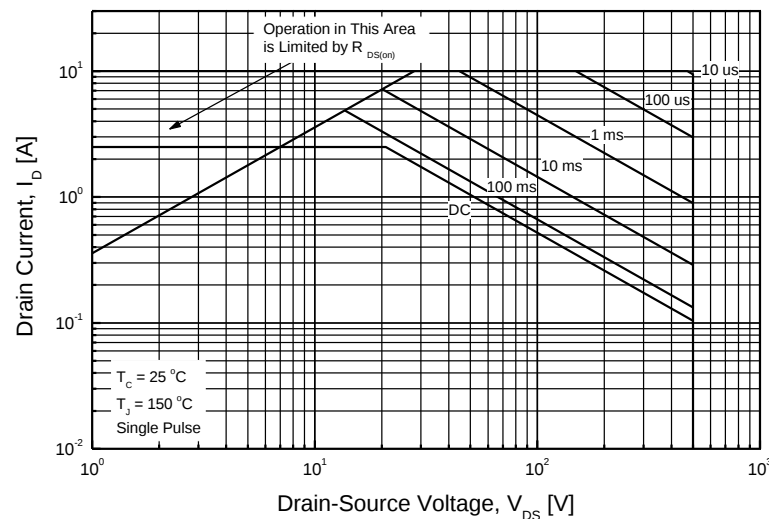
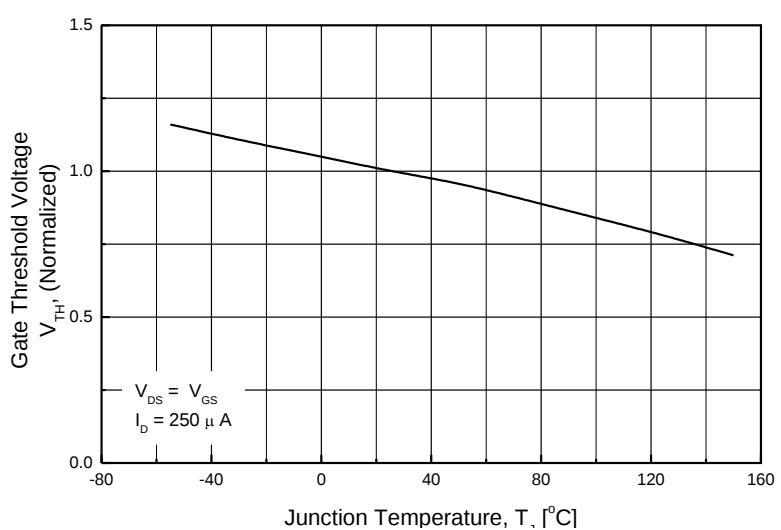
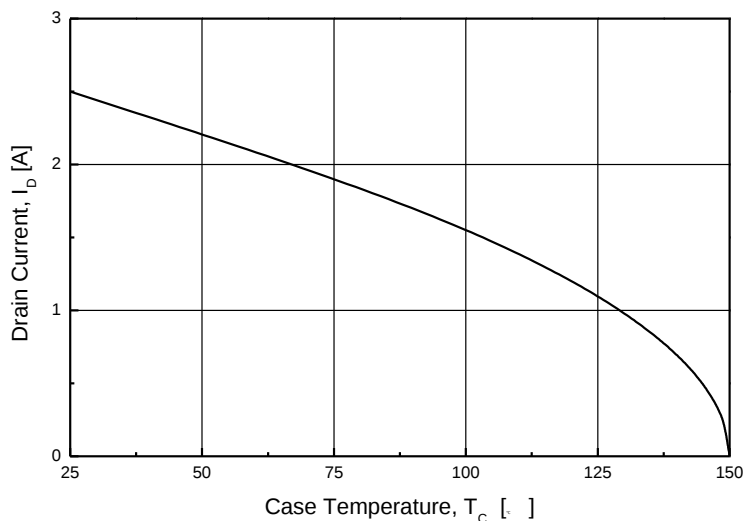
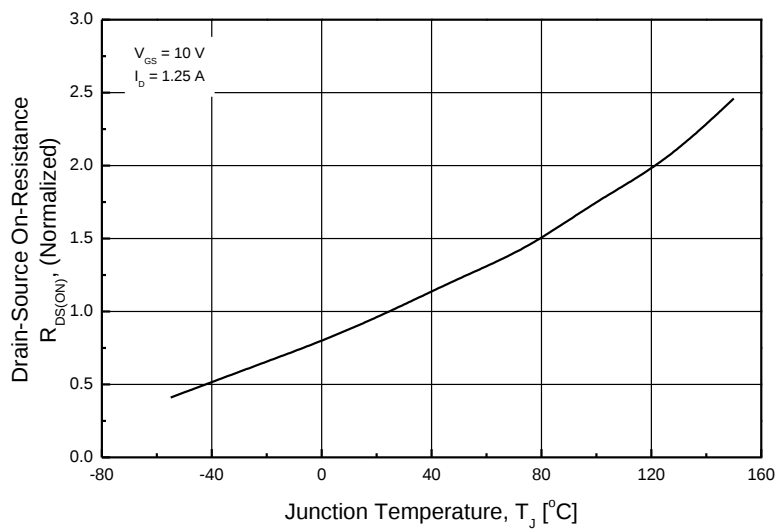
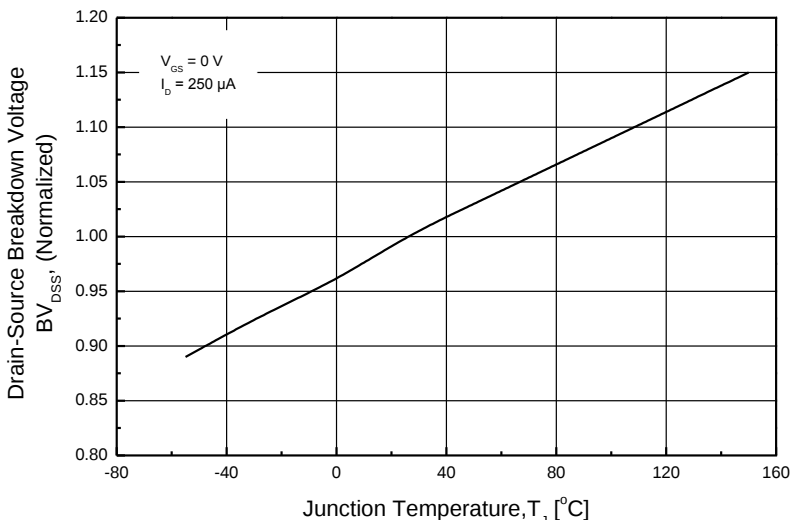
Electrical Characteristics : $T_C=25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test condition	Min	Typ	Max	Units
OFF						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0 V, I _D = 250 μA	500	--	--	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V	--	--	1	μA
		V _{DS} = 400 V, T _C = 125°C	--	--	10	μA
Forward Gate-Source Leakage Current	I _{GSSF}	V _{GS} = 30 V, V _{DS} = 0 V	--	--	100	μA
Reverse Gate-Source Leakage Current	I _{GSSR}	V _{GS} = -30 V, V _{DS} = 0 V	--	--	-100	μA
ON						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	2	--	4	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 1.25 A	--	2.3	2.8	Ω
Forward Transconductance ^(Note 4)	g _{FS}	V _{DS} = 30 V, I _D = 1.25 A	--	5	--	S
DYNAMIC						
Input Capacitance	C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz	--	395	--	pF
Output Capacitance	C _{oss}		--	44	--	pF
Reverse Transfer Capacitance	C _{rss}		--	7.8	--	pF
SWITCHING						
Turn-On Delay Time ^(Note 4,5)	t _{d(on)}	V _{DD} = 250 V, I _D = 2.5 A, R _G = 25 Ω	--	16	--	ns
Turn-On Rise Time ^(Note 4,5)	t _r		--	19	--	ns
Turn-Off Delay Time ^(Note 4,5)	t _{d(off)}		--	62	--	ns
Turn-Off Fall Time ^(Note 4,5)	t _f		--	18	--	ns
Total Gate Charge ^(Note 4,5)	Q _g	V _{DS} = 400V, I _D = 2.5 A, V _{GS} = 10 V	--	9.2	--	nC
Gate-Source Charge ^(Note 4,5)	Q _{gs}		--	1.6	--	nC
Gate-Drain Charge ^(Note 4,5)	Q _{gd}		--	3.9	--	nC
SOURCE DRAIN DIODE						
Maximum Continuous Drain-Source Diode Forward Current	I _S	----	--	--	2.5	A
Maximum Pulsed Drain-Source Diode Forward Current	I _{SM}	----	--	--	10	A
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} = 0 V, I _S = 2.5 A	--	--	1.5	V
Reverse Recovery Time ^(Note 4)	t _{rr}	V _{GS} = 0 V, I _S = 2.5 A	--	230	--	ns
Reverse Recovery Charge ^(Note 4)	Q _{rr}	dI _F / dt = 100 A/μs	--	0.9	--	μC

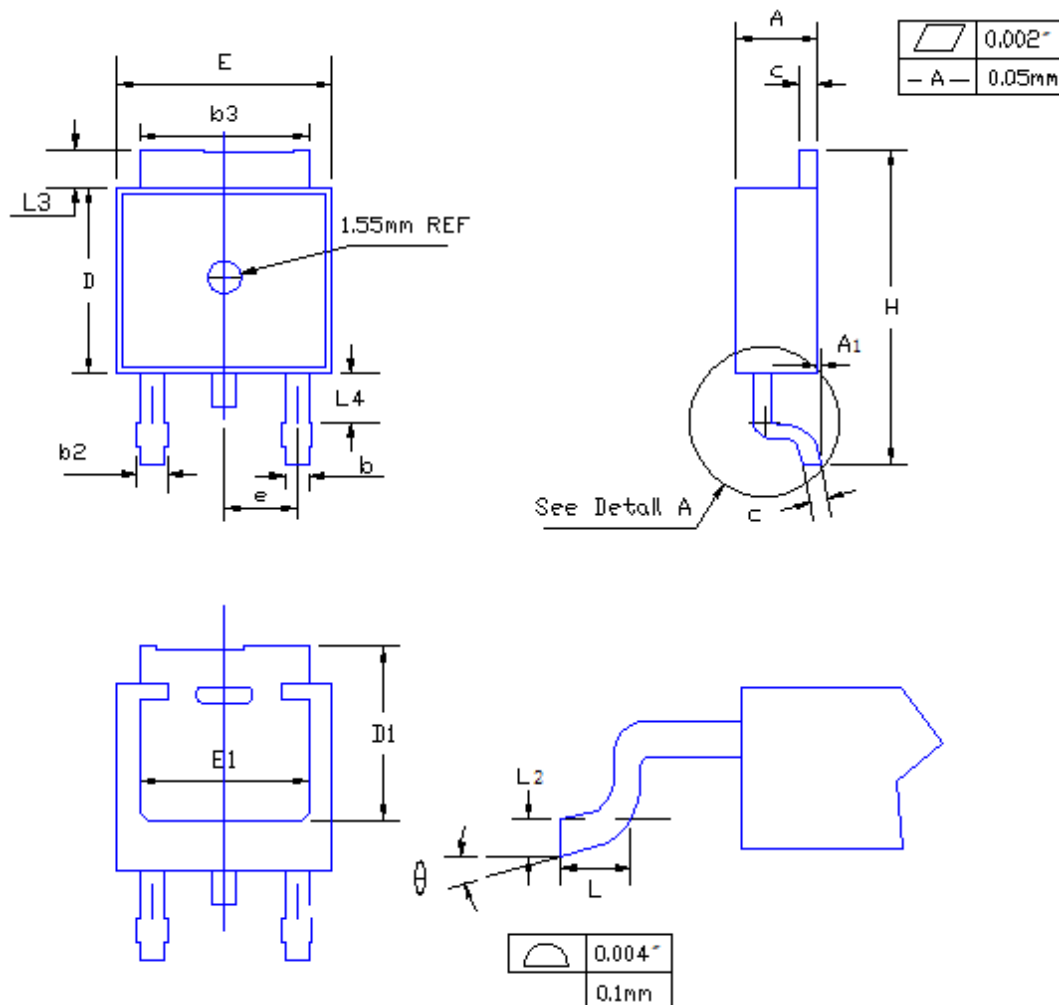
Note :

1. Repeated rating : Pulse width limited by safe operating area
2. $L=30.9\text{ mH}, I_{AS} = 2.5\text{ A}, V_{DD} = 50\text{ V}, R_G = 25\text{ }\Omega$, Starting $T_J = 25^\circ\text{C}$
3. $I_{SD} \leq 2.5\text{ A}, di/dt \leq 200\text{ A}/\mu\text{s}, V_{DD} \leq BV_{DS}$, Starting $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse width $\leq 300\text{ }\mu\text{s}$, Duty Cycle $\leq 2\%$
5. Essentially Independent of Operating Temperature Typical Characteristics



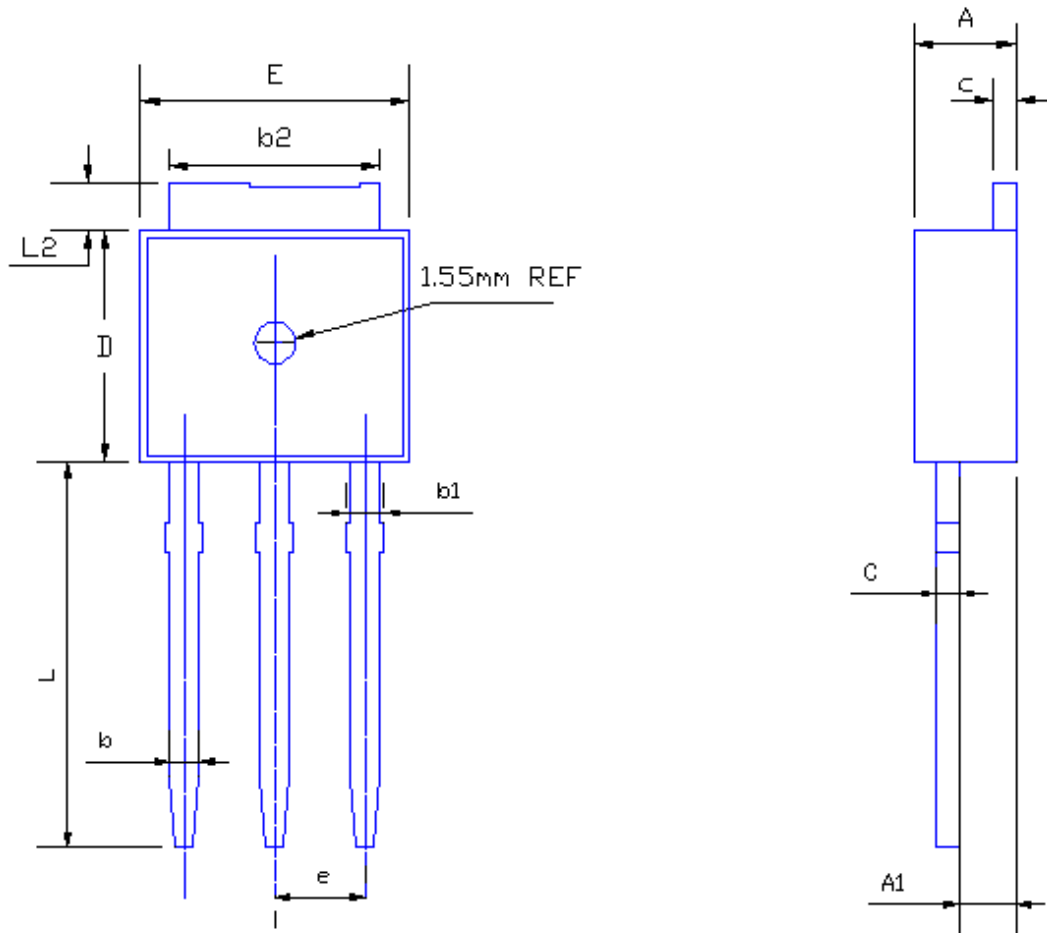


TO-252 (D-PAK) MECHANICAL DATA



SYMBOL	MILLIMETERS	
	MIN	MAX
A	2.19	2.38
A1	—	0.13
b	0.64	0.89
b2	0.84	1.14
b3	5.21	5.46
c	0.46	0.61
D	5.97	6.22
D1	5.21	—
E	6.35	6.73
E1	4.83	—
e	2.29BSC	
H	9.65	10.41
L	1.40	1.78
L2	0.51BSC	
L3	0.89	1.27
L4	0.64	1.01
Ø	0	8

TO-251 (I-PAK) MECHANICAL DATA



SYMBOL	MILLIMETERS	
	MIN	MAX
A	2.19	2.38
A1	1.04	1.23
b	0.64	0.89
b1	0.84	1.14
b2	5.23	5.48
c	0.46	0.61
D	5.91	6.28
E	6.21	6.59
e	2.28 TYP	
L	8.89	9.65
L2	0.89	1.27

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